



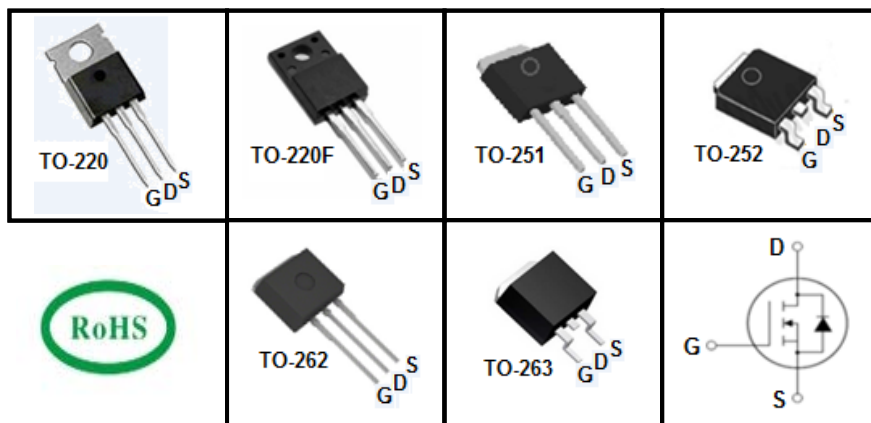
700V Super-Junction Power MOSFET

FEATURES

- Very low FOM $R_{DS(on)} \times Q_g$
- 100% avalanche tested
- RoHS compliant

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)



Device Marking and Package Information

Device	TPP70R450C	TPA70R450C	TPU70R450C	TPD70R450C	TPC70R450C	TPB70R450C
Package	TO-220	TO-220F	TO-251	TO-252	TO-262	TO-263
Marking	70R450C	70R450C	70R450C	70R450C	70R450C	70R450C

Absolute Maximum Ratings $T_C = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Value		Unit
		TO-220, TO-251, TO-252 TO-262, TO-263	TO-220F	
Drain-Source Voltage ($V_{GS} = 0V$)	V_{DSS}	700		V
Continuous Drain Current	I_D	11		A
Pulsed Drain Current (note1)	I_{DM}	33		A
Gate-Source Voltage	V_{GSS}	± 30		V
Single Pulse Avalanche Energy (note2)	E_{AS}	211		mJ
Avalanche Current (note1)	I_{AR}	1.6		A
Repetitive Avalanche Energy (note1)	E_{AR}	0.32		mJ
Power Dissipation ($T_C = 25^\circ\text{C}$)	P_D	78	31.3	W
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55~+150		$^\circ\text{C}$

Thermal Resistance

Parameter	Symbol	Value		Unit
		TO-220, TO-251, TO-252 TO-262, TO-263	TO-220F	
Thermal Resistance, Junction-to-Case	R_{thJC}	1.6	4	$^\circ\text{C/W}$
Thermal Resistance, Junction-to-Ambient	R_{thJA}	62	80	

**Specifications** $T_J = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	700	--	--	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 700V, V _{GS} = 0V, T _J = 25°C	--	--	1	μA
		V _{DS} = 700V, V _{GS} = 0V, T _J = 150°C	--	--	100	
Gate-Source Leakage	I _{GSS}	V _{GS} = ±30V	--	--	±100	nA
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	2.5	--	4.0	V
Drain-Source On-Resistance (Note3)	R _{DS(on)}	V _{GS} = 10V, I _D = 5.5A	--	0.49	0.55	Ω
Forward Transconductance (Note3)	g _{fs}	V _{DS} = 10V, I _D = 5.5A	--	7.8	--	S
Dynamic						
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = 50V, f = 1.0MHz	--	901	--	pF
Output Capacitance	C _{oss}		--	50	--	
Reverse Transfer Capacitance	C _{rss}		--	5.5	--	
Total Gate Charge	Q _g	V _{DD} = 560V, I _D = 11A, V _{GS} = 10V	--	21	--	nC
Gate-Source Charge	Q _{gs}		--	4.7	--	
Gate-Drain Charge	Q _{gd}		--	7.3	--	
Turn-on Delay Time	t _{d(on)}	V _{DD} = 400V, I _D = 11A, R _G = 25Ω	--	41	--	ns
Turn-on Rise Time	t _r		--	20	--	
Turn-off Delay Time	t _{d(off)}		--	123	--	
Turn-off Fall Time	t _f		--	6.4	--	
Drain-Source Body Diode Characteristics						
Continuous Body Diode Current	I _S	T _C = 25°C	--	--	9.2	A
Pulsed Diode Forward Current	I _{SM}		--	--	29	
Body Diode Voltage	V _{SD}	T _J = 25°C, I _{SD} = 11A, V _{GS} = 0V	--	0.9	1.2	V
Reverse Recovery Time	t _{rr}	V _R = 560V, I _F = I _S , di _F /dt = 100A/μs	--	280	--	ns
Reverse Recovery Charge	Q _{rr}		--	2.8	--	μC
Peak Reverse Recovery Current	I _{rrm}		--	17	--	A

Notes

1. Repetitive Rating: Pulse Width limited by maximum junction temperature
2. $I_{AS} = 1.6A, V_{DD} = 50V, R_G = 25\Omega$, Starting $T_J = 25^\circ\text{C}$
3. Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 1\%$



Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 1. Output Characteristics

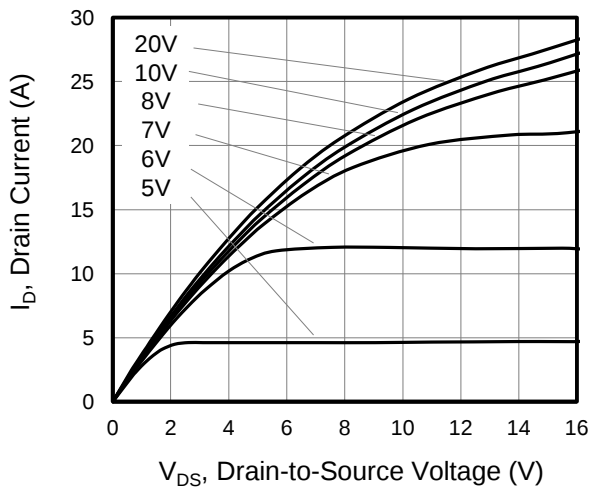


Figure 2. Transfer Characteristics

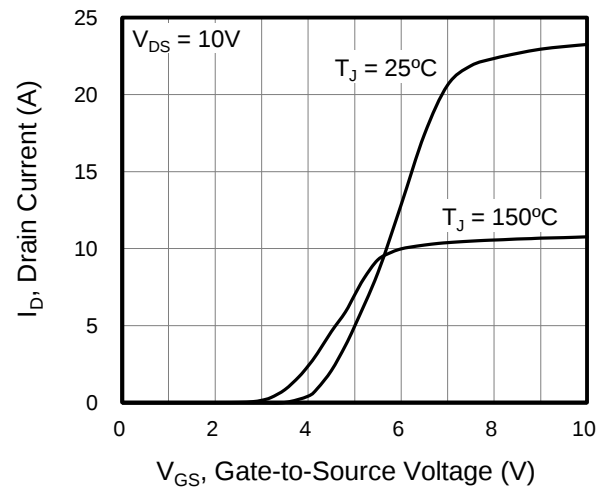


Figure 3. On-Resistance vs. Drain Current

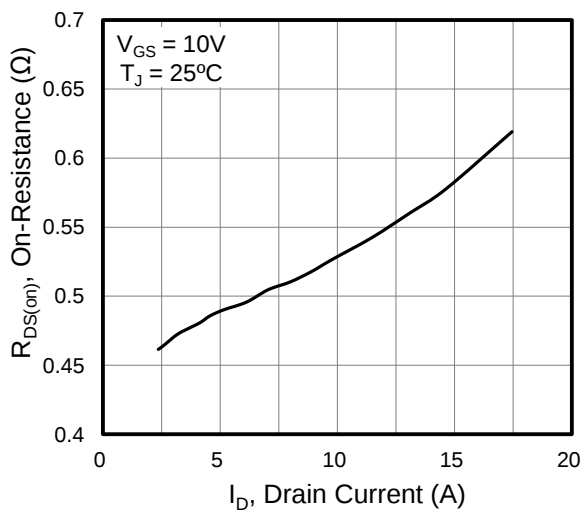


Figure 4. Capacitance

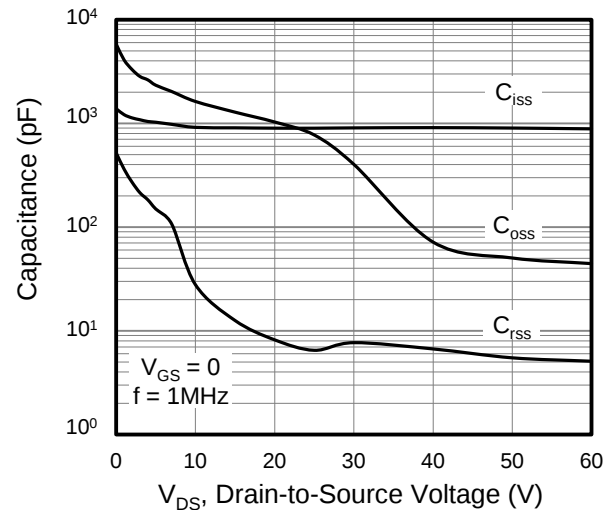


Figure 5. Gate Charge

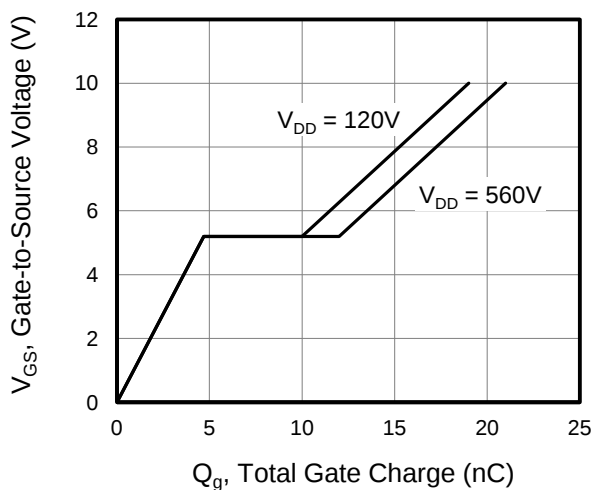
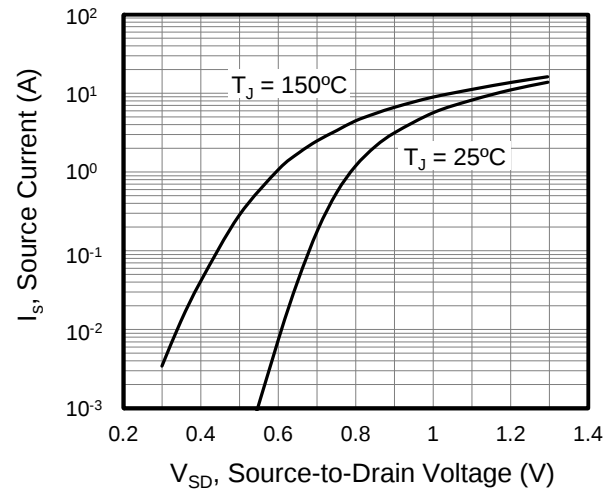


Figure 6. Body Diode Forward Voltage



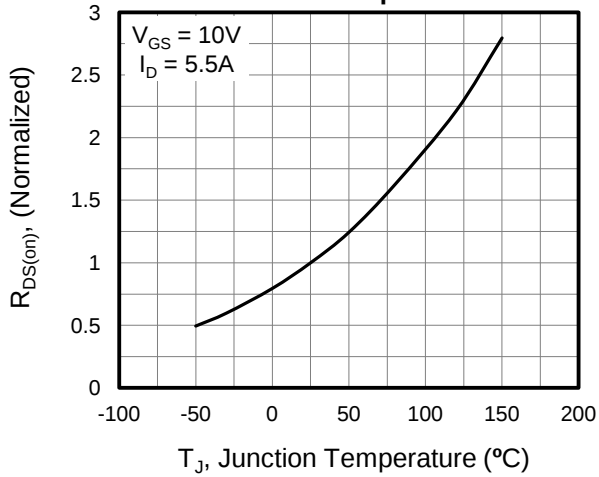
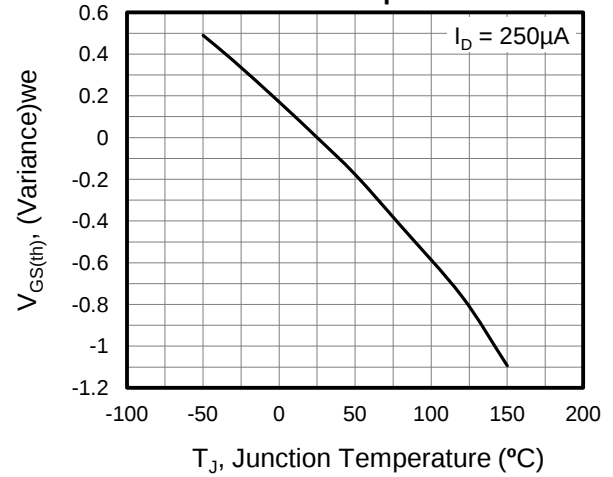
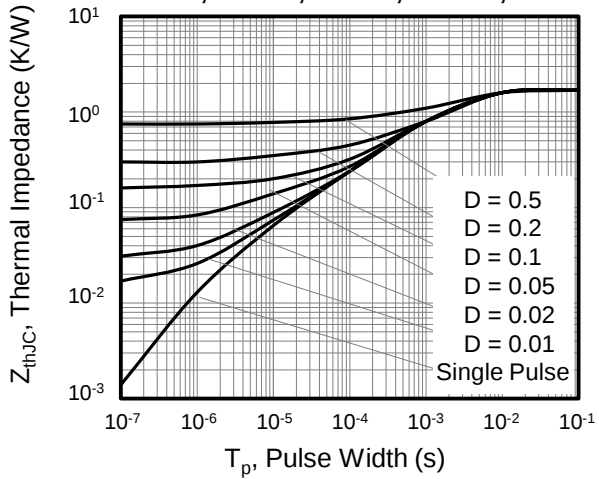
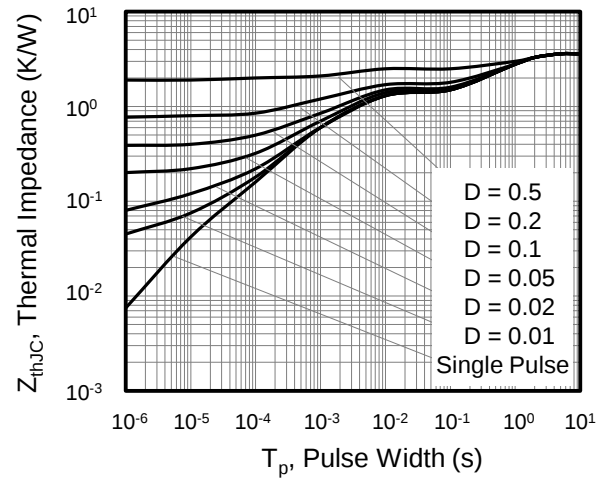
**Typical Characteristics** $T_J = 25^\circ\text{C}$, unless otherwise noted**Figure 7. On-Resistance vs. Junction Temperature****Figure 8. Threshold Voltage vs. Junction Temperature****Figure 9. Transient Thermal Impedance TO-220, TO-251, TO-252, TO-262, TO-263****Figure 10. Transient Thermal Impedance TO-220F**



Figure A: Gate Charge Test Circuit and Waveform

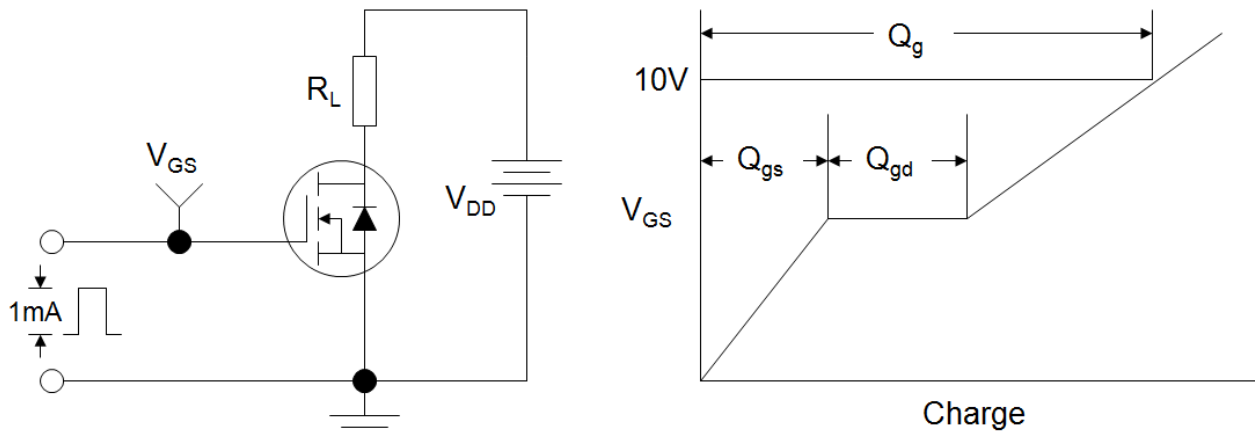


Figure B: Resistive Switching Test Circuit and Waveform

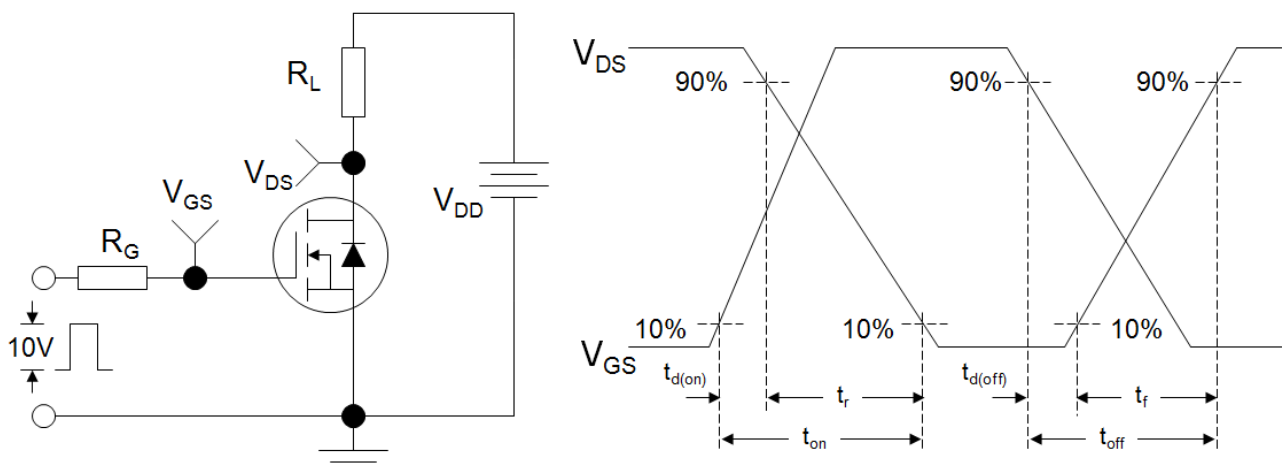
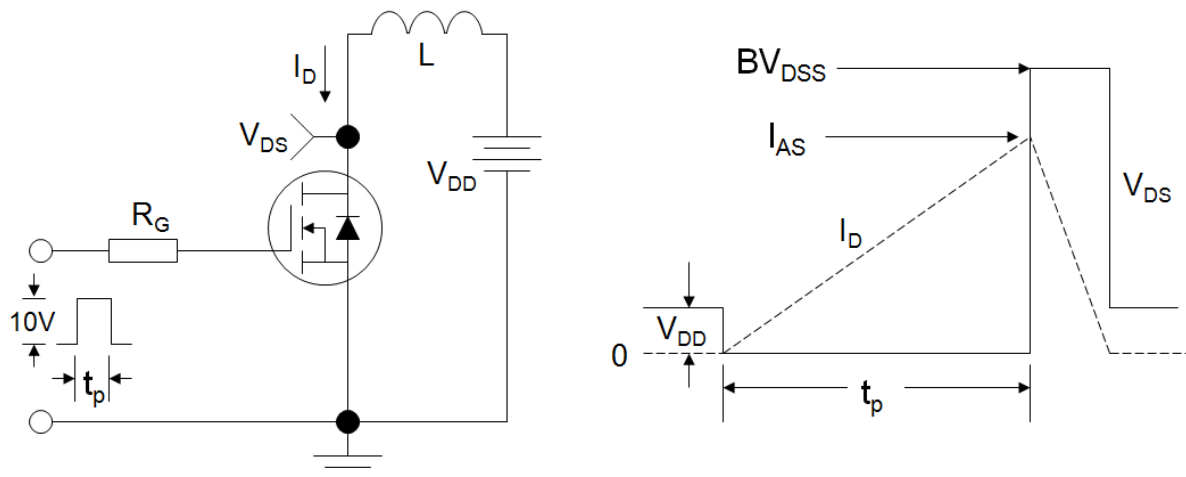
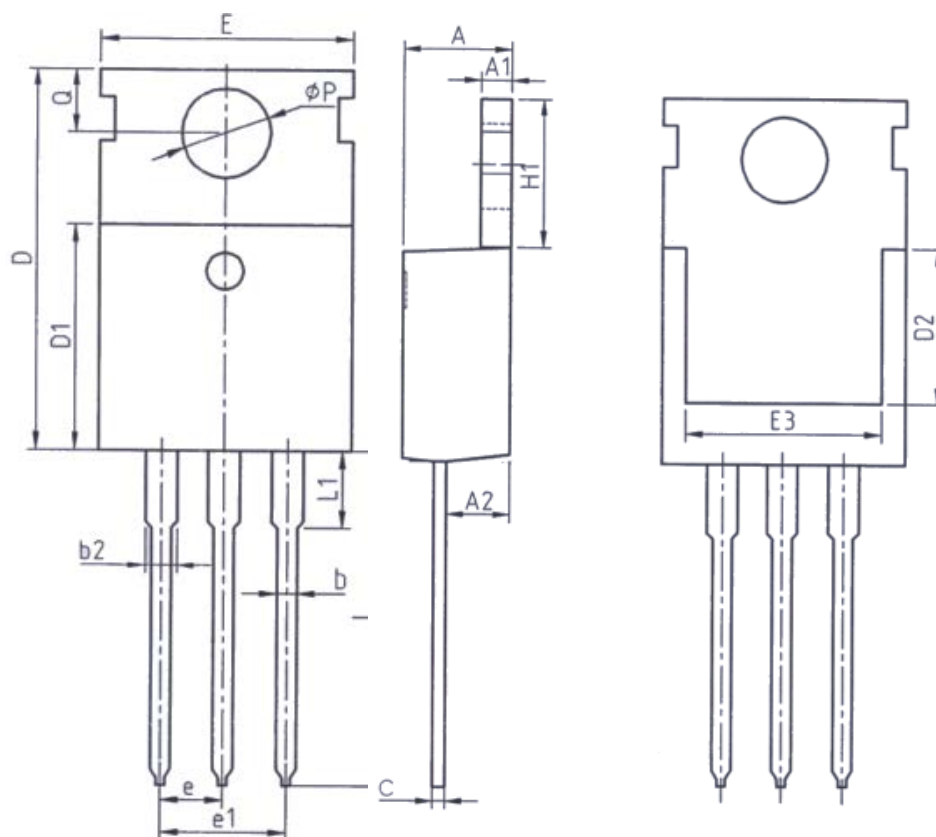


Figure C: Unclamped Inductive Switching Test Circuit and Waveform



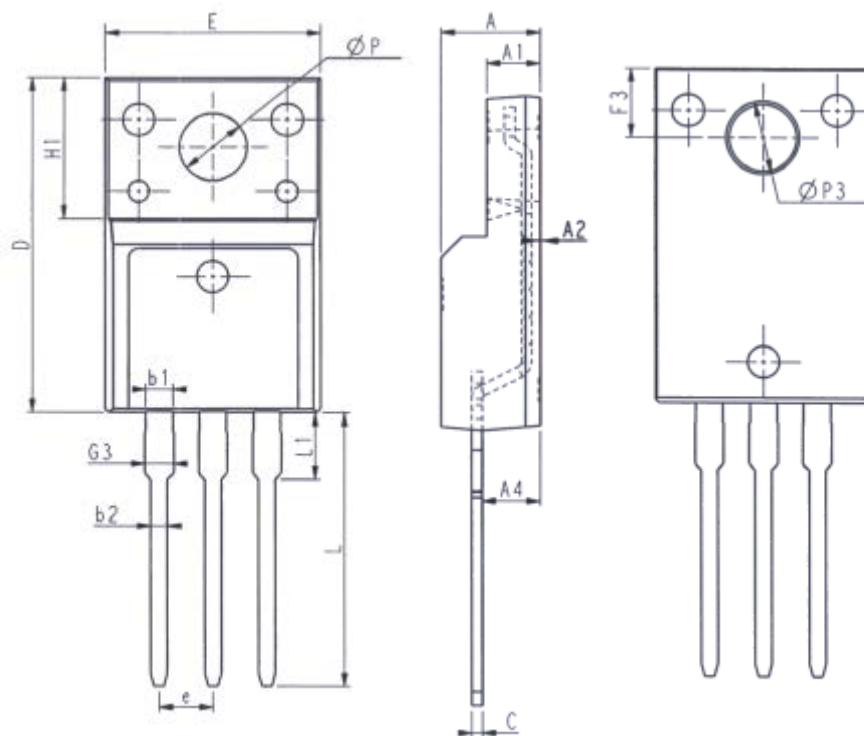


TO-220



Unit: mm		
Symbol	Min.	Max.
A	4.37	4.77
A1	1.25	1.45
A2	2.20	2.60
b	0.70	0.95
b2	1.17	1.47
c	0.40	0.65
D	15.10	16.10
D1	8.80	9.40
D2	5.50	—

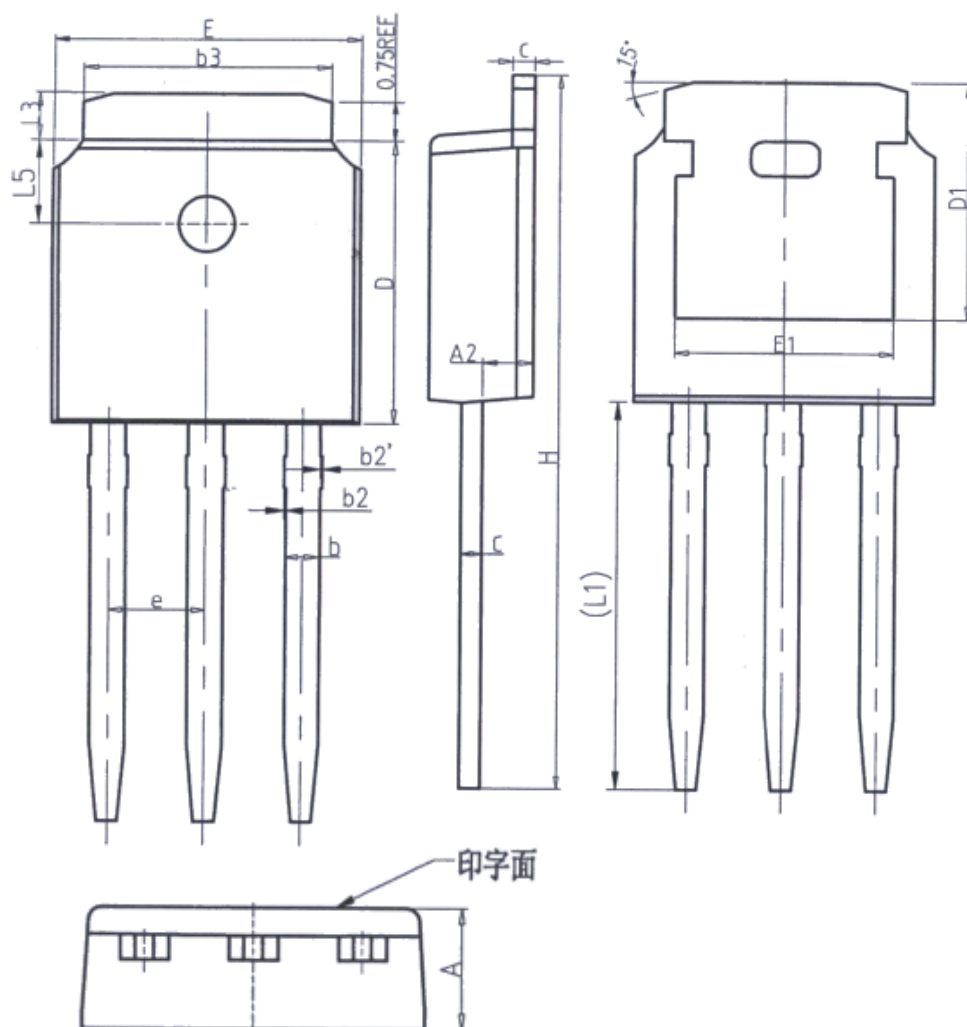
Unit: mm		
Symbol	Min.	Max.
E	9.70	10.30
E3	7.00	—
e	2.54BSC	
e1	5.08BSC	
H1	6.25	6.85
L	12.75	13.80
L1	—	3.40
P	3.40	3.80
Q	2.60	3.00

**TO-220F**

Unit: mm			Unit: mm		
Symbol	Min.	Max.	Symbol	Min.	Max.
E	9.96	10.36	L	12.68	13.28
A	4.50	4.90	L1	2.93	3.13
A1	2.34	2.74	P	3.03	3.38
A2	0.30	0.60	P3	3.15	3.65
A4	2.56	2.96	F3	3.15	3.45
c	0.40	0.65	G3	1.25	1.55
D	15.57	16.17	b1	1.18	1.43
H1	6.70REF		b2	0.70	0.95
e	2.54BSC				



TO-251

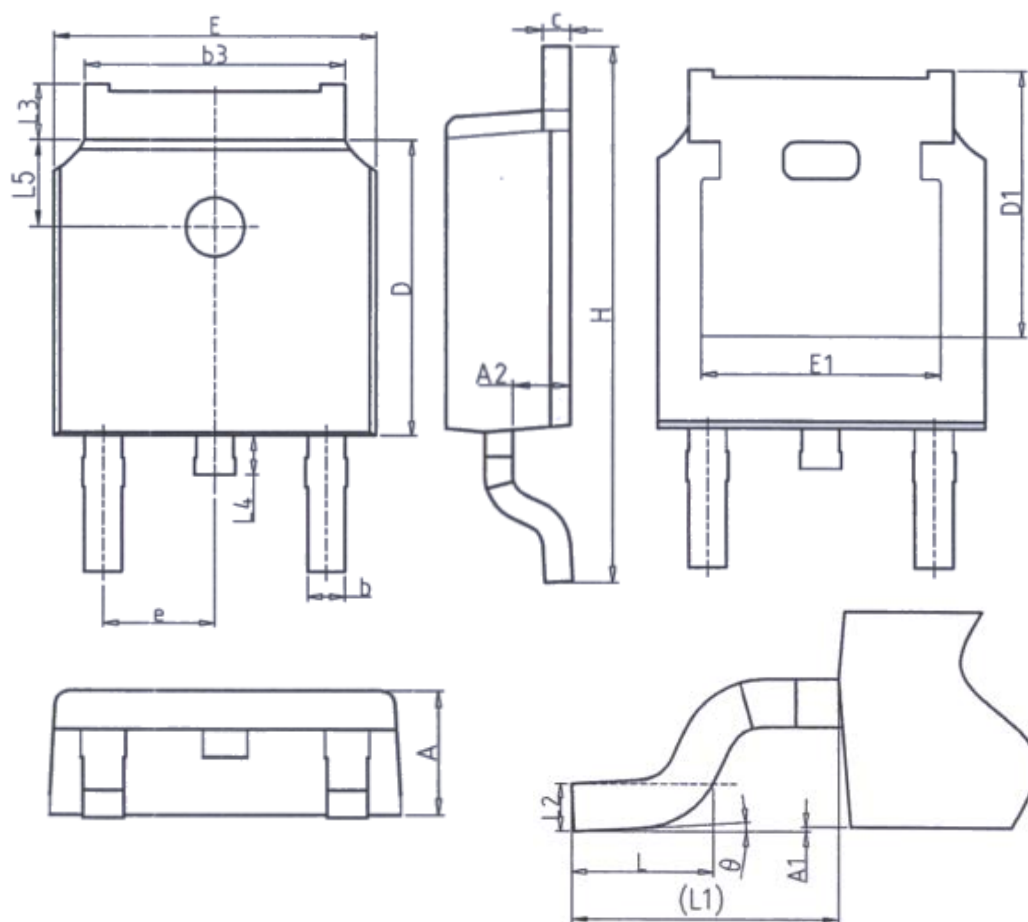


Unit: mm		
Symbol	Min.	Max.
A	2.20	2.40
A2	0.97	1.17
b	0.68	0.90
b2	0.00	0.10
b2'	0.00	0.10
b3	5.20	5.50
c	0.43	0.63
D	5.98	6.22

Unit: mm		
Symbol	Min.	Max.
D1	5.30REF	
E	6.40	6.80
E1	4.63	-
e	2.286BSC	
H	16.22	16.82
L1	9.15	9.65
L3	0.88	1.28
L5	1.65	1.95



TO-252

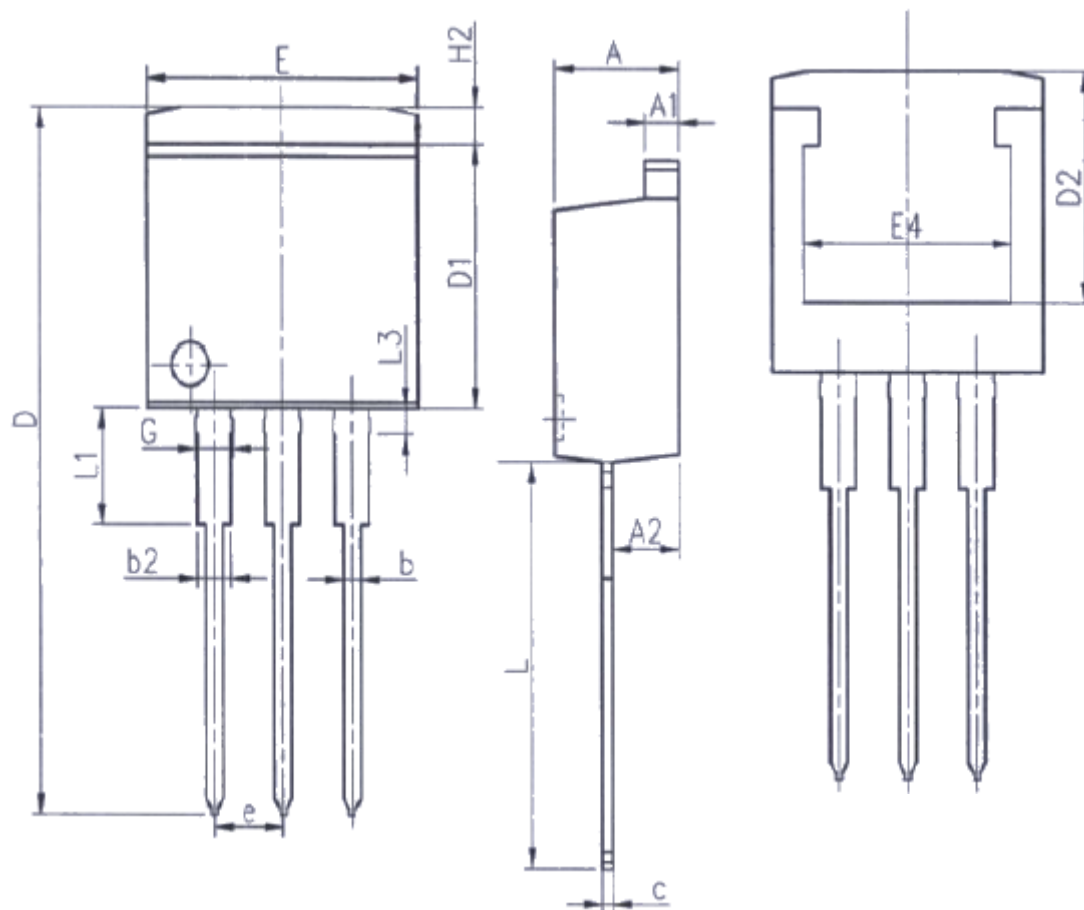


Unit: mm		
Symbol	Min.	Max.
A	2.20	2.40
A1	0.00	0.20
A2	0.97	1.17
b	0.68	0.90
b3	5.20	5.50
c	0.43	0.63
D	5.98	6.22
D1	5.30REF	
E	6.40	6.80
E1	4.63	—

Unit: mm		
Symbol	Min.	Max.
e	2.286BSC	
H	9.40	10.50
L	1.38	1.75
L1	2.90REF	
L2	0.51BSC	
L3	0.88	1.28
L4	—	1.00
L5	1.65	1.95
θ	0°	8°

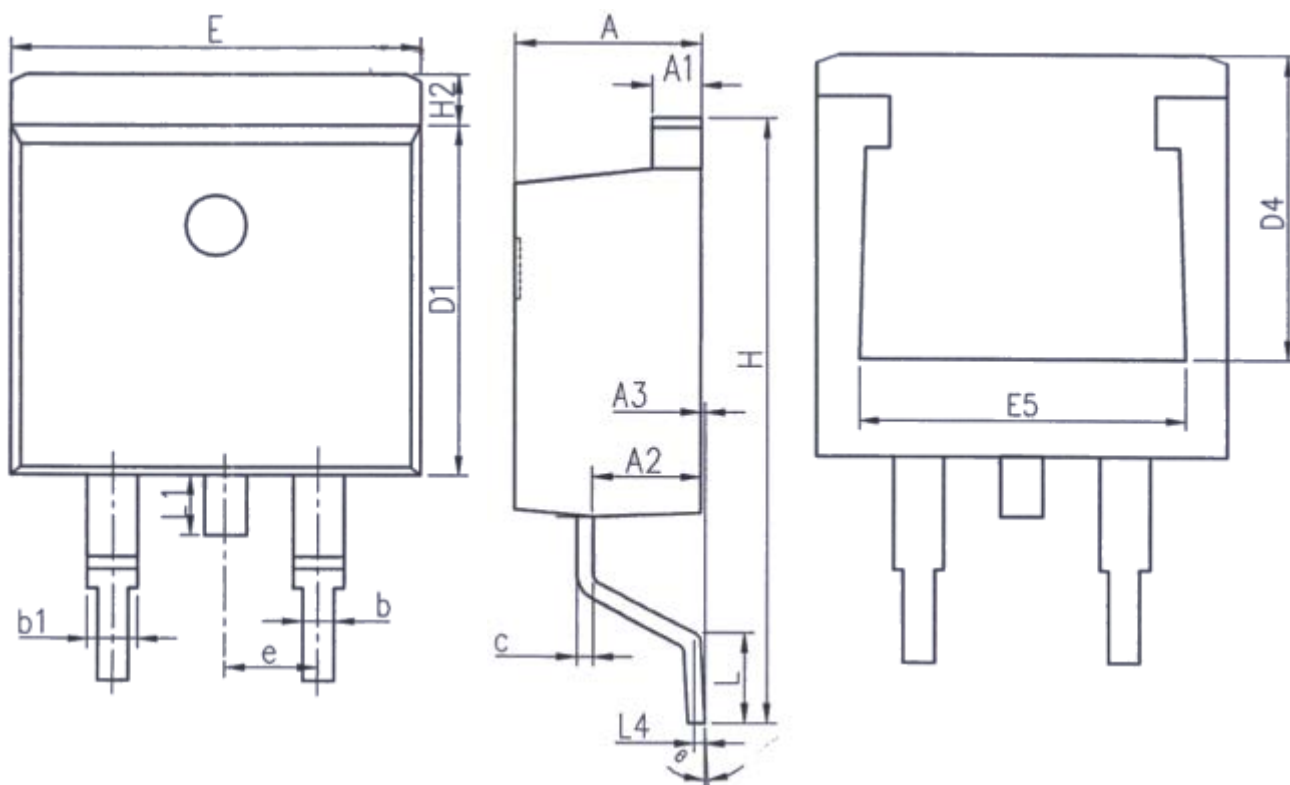


TO-262



Unit: mm		
Symbol	Min.	Max.
A	4.37	4.77
A1	1.22	1.42
A2	2.47	2.87
b	0.70	0.97
b2	1.17	1.42
c	0.28	0.53
D	23.20	24.02
D1	8.38	8.90
D2	6.00	-

Unit: mm		
Symbol	Min.	Max.
E	9.90	10.39
E4	7.30	-
e	2.54BSC	
G	1.25	1.50
H2	-	1.31
L	13.34	14.10
L1	3.30	4.06
L3	0.95	1.15

**TO-263**

Unit: mm		
Symbol	Min.	Max.
A	4.37	4.77
A1	1.22	1.42
A2	2.49	2.89
A3	0.00	0.25
b	0.70	0.96
b1	1.17	1.47
c	0.30	0.53
D1	8.50	8.90
D4	6.60	-

Unit: mm		
Symbol	Min.	Max.
E	9.86	10.36
E5	7.06	-
e	2.54BSC	
H	14.70	15.50
H2	1.07	1.47
L	2.00	2.60
L1	1.40	1.70
L4	0.25BSC	
θ	0°	9°



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